

1. Package summary

Terminal position code Q (quad)

Package type descriptive code LQFP

Package type industry code LQFP176

Package style descriptive code LQFP (low profile quad flat package)

Package body material type P (plastic)

JEDEC package outline code MS-026 BGA

Mounting method type S (surface mount)

Issue date30-5-2016Manufacturer package code98ASS23479W

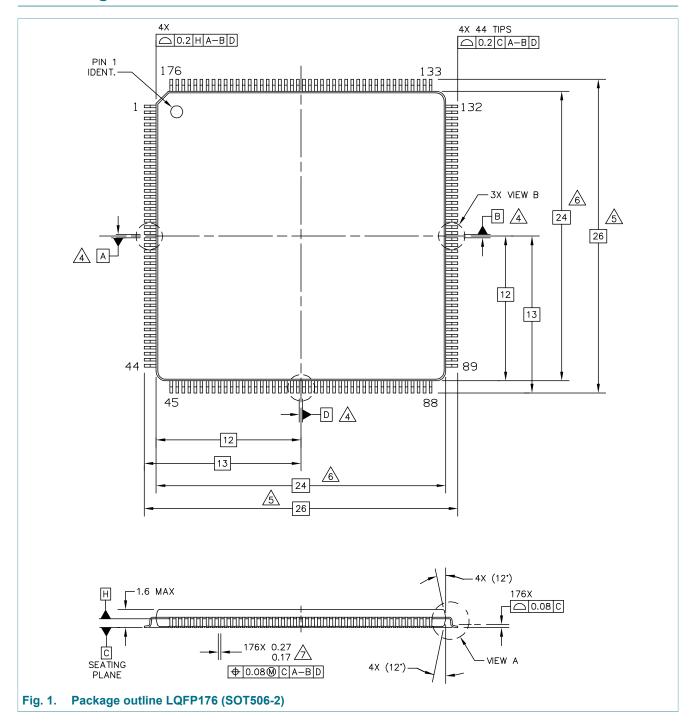
Table 1. Package summary

Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	-	-	24	-	mm
E	package width	-	-	24	-	mm
Α	seated height	-	-	1.4	1.6	mm
е	nominal pitch	-	-	0.5	-	mm
n ₂	actual quantity of termination	-	-	176	-	



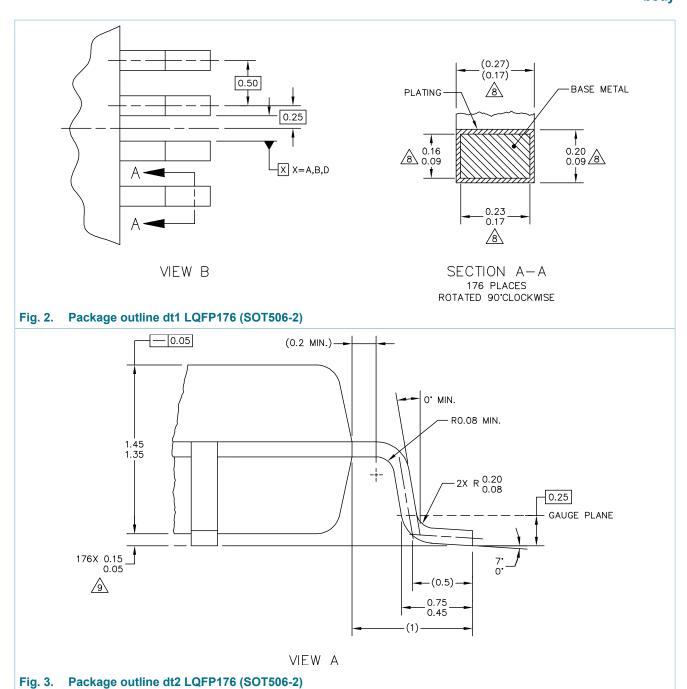
plastic, low profile quad; flat leaded package; 176 terminals; 0.50 mm pitch; 24 mm x 24 mm x 1.4 mm body

2. Package outline



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plastic, low profile quad; flat leaded package; 176 terminals; 0.50 mm pitch; 24 mm x 24 mm x 1.4 mm body



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NOTES:

- 1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M-1994.
- 2. DIMENSIONS IN MILLIMETERS.
- 3. DATUM PLANE H IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
- A DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- THIS DIMENSIONS TO BE DETERMINED AT SEATING PLANE, DATUM C.
- THIS DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 PER SIDE. THIS DIMENSIONS INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.35. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD 0.07.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.1 MM AND 0.25 MM FROM THE LEAD TIP.
- DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

Fig. 4. Package outline note LQFP176 (SOT506-2)

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3. Legal information

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